<table>
<thead>
<tr>
<th>Symbol</th>
<th>Hit Count</th>
<th>Tool Size</th>
<th>Plated</th>
<th>Hole Type</th>
</tr>
</thead>
<tbody>
<tr>
<td>○</td>
<td>100</td>
<td>16mil (0.406mm)</td>
<td>PTH</td>
<td>Round</td>
</tr>
<tr>
<td>▽</td>
<td>3</td>
<td>28mil (0.711mm)</td>
<td>PTH</td>
<td>Round</td>
</tr>
<tr>
<td>×</td>
<td>15</td>
<td>40mil (1.016mm)</td>
<td>PTH</td>
<td>Round</td>
</tr>
<tr>
<td>☆</td>
<td>14</td>
<td>43.307mil (1.1mm)</td>
<td>PTH</td>
<td>Round</td>
</tr>
<tr>
<td>○</td>
<td>4</td>
<td>125.984mil (3.2mm)</td>
<td>PTH</td>
<td>Round</td>
</tr>
</tbody>
</table>

136 Total

Drill Table
FOR 16MIL DRILL +/−16MIL
FOR PTH DRILL +/−3MIL

Diagram of drilled holes.
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